Motor Driver, Single-Phase, PWM, Full-Wave, 24 V/48 V **BLDC Motor**

Overview

The LV88561JA/R, LV88562JA/R, LV88563JA/R and LV88564JA/R are the pre-driver for a single-phase 24 V/48 V BLDC motor, which have the closed loop controller for motor rotation speed. These are available to control a motor with low vibration and the low noise. In addition, lead-angle adjustment is possible by external pins. Lead-angle value and lead-angle slant can be adjusted independently. Thus, the device can be driven by high efficiency and low noise with various motors. Motor speed setting curve is adjustable with using external resistor only. As a method of the rotary speed control of the motor, direct-PWM pulse input is adopted.

Features

- Single-phase Full Wave Drive Pre-driver Include Closed Loop Speed Control which is Fitting for High Voltage (24 V/48 V) Application
- Speed Control Function by PWM Duty Input (25 Hz to 100 kHz)
- Soft Start-up Function and PWM Soft Switching Phase Transition
- Soft PWM Duty Cycle Transitions
- Built-in Current Limit Circuit and Thermal Protection Circuit
- Built-in Locked Rotor Protection and Auto Recovery Circuit
- Dynamic Lead Angle Adjustment with Respect to Rotational Speed
- Lead-angle Control Parameters can be Configured
- Lineup of Different Closed Loop Gain Selection
- Lineup of Rotation Signal Output Selection
- These are Pb-Free and Halogen-Free Devices

Typical Applications

- PC & Computing Equipment
- Refrigerator
- Games

LV88561, 562, 563, 564 COMPARISON TABLE

	Loop Gain	Rotation Signal
LV88561JA/R	Normal	FG
LV88562JA/R	Normal	RD
LV88563JA/R	Low	FG
LV88564JA/R	Low	RD

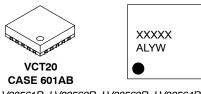


ON Semiconductor®

www.onsemi.com



(LV88561JA, LV88562JA, LV88563JA, LV88564JA)



(LV88561R, LV88562R, LV88563R, LV88564R)

XX = Specific Device Code

- А = Assembly Site (OSPI Tarlac Site Code: MP)
- = Wafer Lot Number 1
- YW = Assembly Start Week
- G = Pb-Free Package

ORDERING INFORMATION

Device	Package	Shipping [†]		
LV88561JA-AH LV88562JA-AH LV88563JA-AH LV88564JA-AH	SSOP20J (Pb–Free / Halogen Free)	2000 / Tape & Reel		
LV88561RTXG LV88562RTXG LV88563RTXG LV88564RTXG	VCT20 (Pb–Free / Halogen Free)	2000 / Tape & Reel		

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

BLOCK DIAGRAM

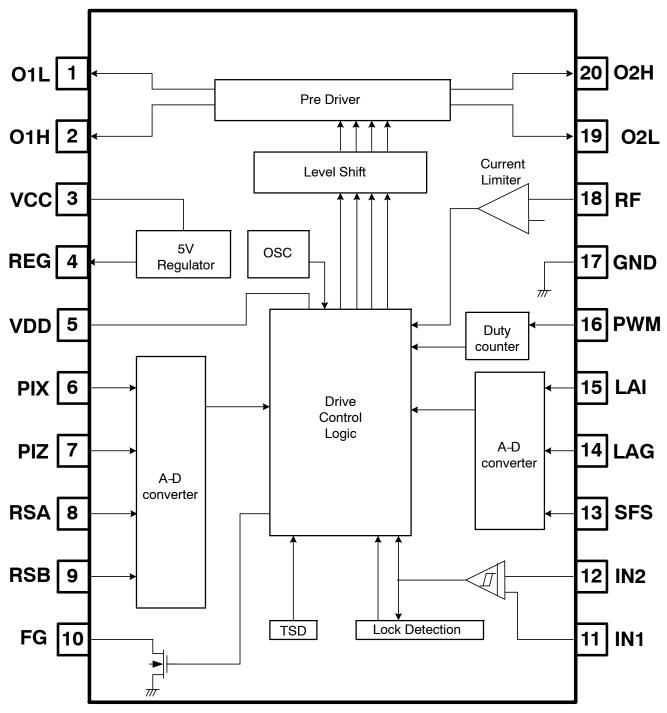


Figure 1. LV88561JA, LV88562JA, LV88563JA, LV88564JA Block Diagram

APPLICATION CIRCUIT DIAGRAM

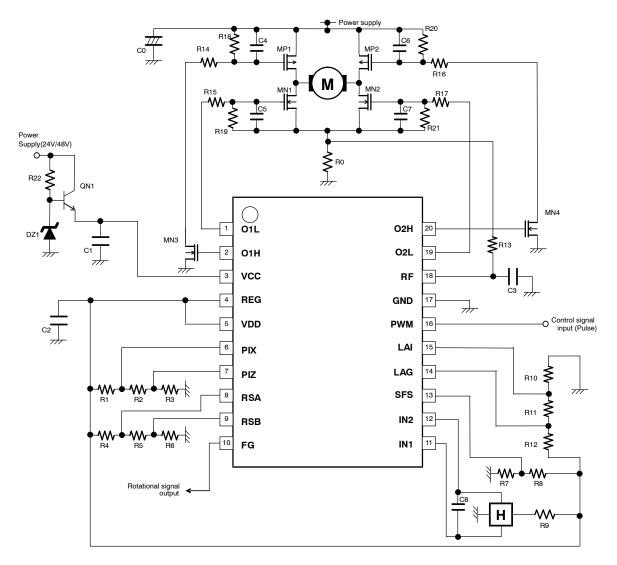


Figure 2. Single-phase BLDC Motor Drive with LV88561JA, LV88562JA, LV88563JA, LV88564JA

Device	Value	Device	Value
MP1+MN1	FW389	R14	100 Ω
MP2+MN2	FW389	R15	100 Ω
MN3,4	MCH3486	R16	100 Ω
QN1	NMBTA05LT1G	R17	100 Ω
DZ1	MM3Z12VT1G(12V Zener)	R18	*
		R19	*
R0	0.051 Ω // 0.051 Ω	R20	*
R1	0 to 50 kΩ	R21	*
R2	0 to 50 kΩ	R22	5.1 kΩ
R3	0 to 50 kΩ		
R4	0 to 50 kΩ		
R5	0 to 50 kΩ	C0	4.7 μF –10 uF
R6	0 to 50 kΩ	C1	0.1 μF – 1 μF
R7	0 to 50 kΩ	C2	0.1 μF – 1 μF
R8	0 to 50 kΩ	C3	**
R9	2.2 kΩ	C4	0 to 1500 pF
R10	0 to 50 kΩ	C5	0 to 1500 pF
R11	0 to 50 kΩ	C6	0 to 1500 pF
R12	0 to 50 kΩ	C7	0 to 1500 pF
R13	0 Ω	C8	0 to 0.1 μF

Table 1. EXAMPLE COMPONENT VALUE

*Depend on the user circuit, MP1, MP2, MN1 and MN2. **Depends on the user environment.

Table 2. TRUTH TABLE

Operating State	IN1	IN2	Inner-PWM State*	O1H	01L	O2H	O2L	FG
Rotation – drive mode	L	Н	On	L	н	н	L	OFF
	Н	L		н	L	L	Н	L
Rotation – regeneration mode	L	Н	Off	L	L	Н	L	OFF
	Н	L		Н	L	L	L	L
Lock protector	L	Н	-	L	L	L	L	OFF
	Н	L	1	L	L	L	L	L

*Inner PWM state means the OUTPUT active period decided by inner control logic. Don't match with PWM-pin input signal.

PIN ASSIGNMENT

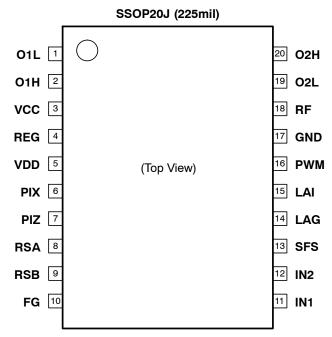


Figure 3. LV88561JA, LV88562JA, LV88563JA, LV88564JA Pin Assignment

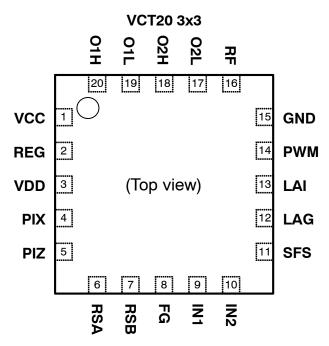


Figure 4. LV88561R, LV88562R, LV88563R, LV88564R Pin Assignment

Pin No.	Pin name	Function
1 19	O1L O2L	Output pins of the low-side gate-drive signal. (See "Truth Table" on page 4 for the polarity)
2 20	01H 02H	Output pins of the high-side gate-drive signal. (See "Truth Table" on page 4 for the polarity)
3	VCC	Power supply pin. The input voltage to this pin must be stabilized without the influence of the noise, ripple, and etc. Therefore, it is necessary to connect the capacitor near VCC pin and GND pin as much as possible.
4	REG	Output pin of the regulated voltage (5.0 V). It is necessary to connect the capacitor near this pin and GND pin for stabilizing this regulated voltage.
5	VDD	Logic circuit power supply pin. This pin should be shorted to REG pin.
6 7	PIX PIZ	PWM input duty adjust pins at the point of maximum or minimum rotation speed.
8 9	RSA RSB	Maximum or minimum rotation speed adjust pins.
10	FG	Output pin of the rotational signal. For LV88561 and LV88563, it functions as FG (Frequency Generator) and for LV88562 and LV88564, it functions as RD (Rotation Detection). This pin should be opened (disconnected) when not in use.
11 12	IN1 IN2	Hall signal input pins.
13	SFS	Soft start adjust pin.
14	LAG	Lead angle gradient adjust pin.
15	LAI	Initial lead angle adjust pin in minimum rotation speed.
16	PWM	PWM input pin of the speed control signal as the rectangular wave.
17	GND	GND pin.
18	RF	Output current detect pin. When the voltage level at this pin exceeds the internal set detection level, outputs turn to the regenerating mode.

Table 3. PIN FUNCTION DESCRIPTION (Pin No. – SSOP20J version)

Table 4. MAXIMUM RATINGS

Parameter	Symbol	Conditions	Ratings	Unit
Maximum supply voltage	VCC _{max}	VCC pin	20	V
Maximum output voltage	VOUTmax	O1H/O1L/ O2H/O2L pin	20	V
Maximum output current	IOUT _{max}	O1H/O1L/ O2H/O2L pin	50	mA
Maximum output peak current (Note 1)	IOUTpeak	O1H/O1L/ O2H/O2L pin	150	mA
REG pin maximum output current	IREGmax	REG pin	20	mA
RSA/RSB/PIX/PIZ/LAI/LAG/SFS/IN1/IN2/RF pin maximum input voltage	VIN max	RSA/RSB/PIX/ PIZ/LAI/LAG/IN1/ IN2/SFS/RF pin	5.5	V
PWM pin maximum input voltage	VPWMmax	PWM pin	5.5	V
FG pin withstanding voltage	VFGmax	FG pin	20	V
FG pin maximum output current	IFGmax	FG pin	10	mA
Allowable power dissipation (Note 2)	Pdmax	LV8856xJA	0.8	W
Allowable power dissipation (Note 3)	Pdmax	LV8856xR	1.0	W
Operating temperature	Topr		-40 to +105	°C
Storage temperature	Tstg		–55 to +150	°C
Maximum junction temperature	Tjmax		150	°C
Moisture Sensitivity Level (MSL) (Note 4)	MSL	LV8856xJA	3	-
Moisture Sensitivity Level (MSL) (Note 4)	MSL	LV8856xR	1	-
Lead Temperature Soldering Pb-Free Versions (30s or less) (Note 5)	T _{SLD}		255	°C
ESD Human body Model : HBM (Note 6)	ESD _{HBM}		±2000	V

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. IOUT_{peak} is the peak value of the motor supply current with duty_cycle < 5%.

- Specified circuit board : 114.3 mm x 76.1 mm x 1.6 mm, glass epoxy single layer board. It has 1 oz internal power and ground planes and 1/2 oz copper traces. Please refer to Thermal Test Conditions on page 23.
- 3. Specified circuit board : 50.0 mm x 40.0 mm x 0.8 mm, glass epoxy 4–layer board. It has 1 oz internal power and ground planes and 1/2 oz copper traces on top and bottom of the board. Please refer to Thermal Test Conditions on page 23.

4. Moisture Sensitivity Level (MSL): IPC/JEDEC standard: J-STD-020A

- 5. For information, please refer to our Soldering and Mounting Techniques Reference Manual, SOLDERRM/D http://www.onsemi.com/pub_link/Collateral/SOLDERRM-D.PDF
- 6. ESD Human Body Model is based on JEDEC standard: JESD22-A114

Table 5. THERMAL CHARACTERISTICS

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Ambient (Note 7) LV8856xJA	$R_{ hetaJA}$	156	°C/W
Thermal Resistance, Junction-to-Ambient (Note 8) LV8856xR	$R_{ hetaJA}$	125	°C/W

 Specified circuit board : 114.3 mm x 76.1 mm x 1.6 mm, glass epoxy single layer board. It has 1 oz internal power and ground planes and 1/2 oz copper traces on top and bottom of the board. Please refer to Thermal Test Conditions on page 23.

8. Specified circuit board : 50.0 mm x 40.0 mm x 0.8 mm, glass epoxy 4–layer board. It has 1 oz internal power and ground planes and 1/2 oz copper traces on top and bottom of the board. Please refer to Thermal Test Conditions on page 23.

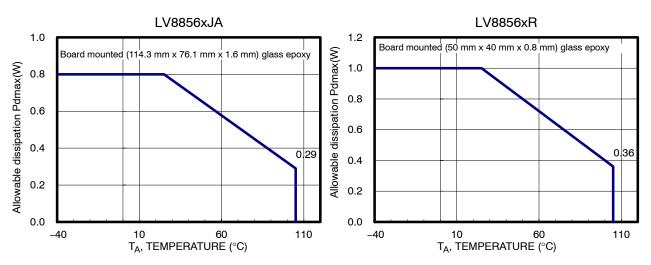


Figure 5. Power Dissipation vs Ambient Temperature Characteristic

Table 6	. RECOMMENDED	OPERATING	RANGES	(Note 9)
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Parameter	Symbol	Conditions	Ratings	Unit
VCC supply voltage	VCCtyp	VCC pin	12	V
VCC operating supply voltage range1	VCCop1	VCC pin	6.0 to 16	V
VCC operating supply voltage range2 (Note 10)	VCCop2	VCC pin	3.9 to 6.0	V
PWM input frequency range	Fpwm	PWM pin	25 to 100k	Hz
PWM minimum input low/high pulse width	Twpwm	PWM pin	100	ns
IN1 input voltage range	Vin1	IN1 pin	0 to VREG	V
IN2 input voltage range	Vin2	IN2 pin	0.3 to 0.55*VREG	V
Control input voltage range	Vcnth	RSA/RSB/PIX/ PIZ/LAI/LAG/SFS pin	0 to VREG	V

9. Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

10. When the VCC voltage below 6.0 V, motor rotation function keep to normally until to 3.9 V. But there are possibility that the ELECTRICAL CHARACTERISTICS is varied.

				Ratings Min Typ Max		
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Circuit current	ICC			9	16	mA
O1H/O1L/O2H/O2L High-side on-resistance	ROHon	IO = 10 mA		30	80	Ω
01H/01L/02H/02L Low-side on-resistance	ROLon	IO = 10 mA		30	80	Ω
O1H/O1L/O2H/O2L PWM output frequency	fpwmo		45.6	48	50.4	kHz
PWM pin low level input voltage	Vpwml		0		0.7	V
PWM pin high level input voltage	Vpwmh		2.8		5.5	V
PWM input resolution	Δpwm			8		Bit
FG pin low level output voltage	Vfgl	IFG = 5 mA		0.2	0.3	V
FG pin leak current	lfglk	VCC = 16 V VFG = 16 V			1	μΑ
REG pin output voltage	VREG		4.7	5.0	5.3	V
Lock-detection time1 (Note 12)	Tld1	Under rotation	0.27	0.3	0.33	S
Lock-detection time2 (Note 13)	Tld2	Start-up	0.63	0.7	0.77	S
Lock-Stop release time1 from 1 st to 4 th off time	Tlroff1		3.1	3.5	3.9	S
Lock-Restart on time	Tlron		0.63	0.7	0.77	S
Lock-Restart time ratio1	Rlr1	Tlroff1/Tlron		5		-
Lock-Stop release time2(Note 14) as from 5 th off time	Tlroff2		12.5	14	15.5	S
Lock-Restart time ratio2(Note 14) as from 5 th off time	Rlr2	Tlroff2/Tlron		20		-
Thermal protection detection temperature	Tthp	(Design target)	150	180		°C
Thermal protection detection hysteresis	ΔTthp	(Design target)		40		°C
Current limit detection voltage	VTHCLM	RF-GND	0.09	0.10	0.11	V
REG pin output voltage load regulation	Δ Vregld	IREG = -10 mA		20	50	mV
Hall input bias current	lhin	IN1, IN2 = 0 V		0	1	μΑ
Hall input sensitivity	ΔVhin		40			mV
Control input bias current	Ictlin	PIX, PIZ, RSA, RSB, SFS, LAG, LAI = 0 V		0	1	μΑ
PWM input bias current	lpwmin	VDD = 5.5 V, PWM = 0 V	14	28	42	μΑ
UVLO detection voltage	Vuvdet	VCC voltage	3.1	3.4	3.6	V
UVLO release voltage	Vuvrls	VCC voltage	3.3	3.6	3.9	V
UVLO hysteresis voltage	∆Vuv		0.1	0.2	0.4	V

Table 7. ELECTRICAL CHARACTERISTICS at TA = 25°C, VCC_{OP} = 12 V unless otherwise noted. (Note 11)

11. Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 12. When the motor rotate state and the motor rotation speed reach to below 50 rpm (phase change period over 0.3s), lock protection function

will activate.

13. At the motor start-up timing, the motor can't rotate until 0.7s, lock protection function work.
14. When the locked rotor state is continued for a long time, lock stop period will change from 5th off time.

TYPICAL CHARACTERISTICS

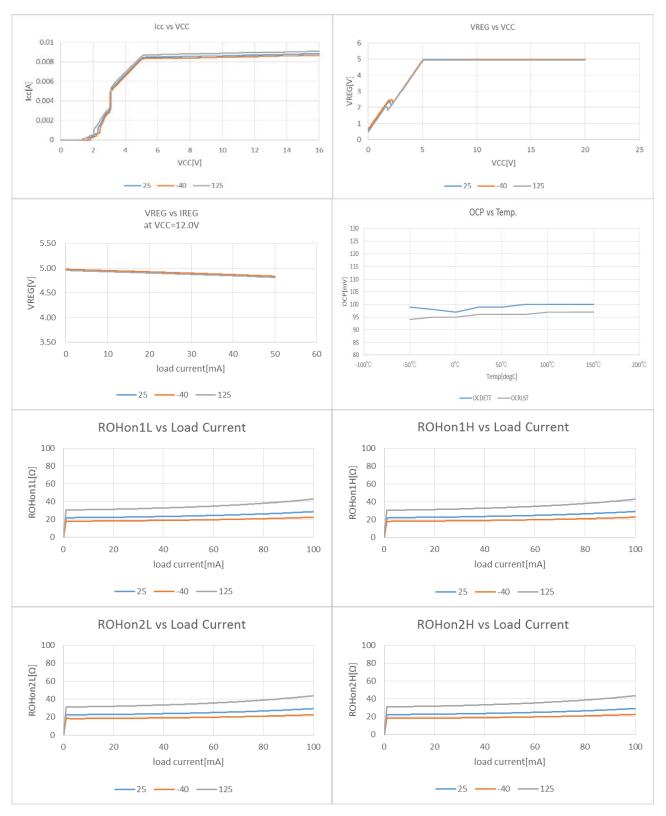
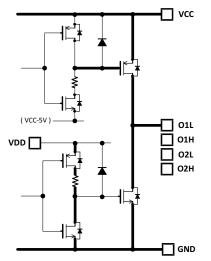
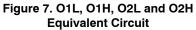


Figure 6. Typical Characteristics

EQUIVALENT CIRCUIT





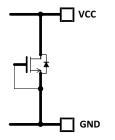


Figure 9. VCC Equivalent Circuit

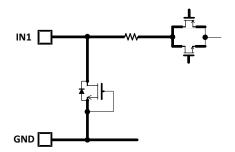


Figure 11. IN1, IN2 Equivalent Circuit

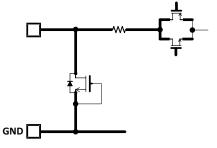


Figure 13. LAI Equivalent Circuit

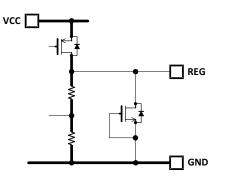


Figure 8. REG Equivalent Circuit

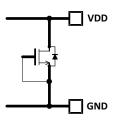


Figure 10. VDD Equivalent Circuit

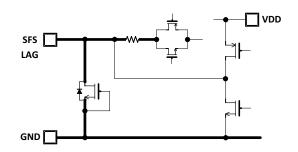


Figure 12. SFS, LAG Equivalent Circuit

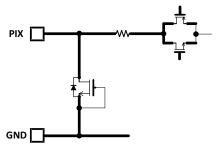
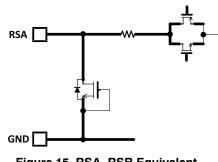


Figure 14. PIX, PIZ Equivalent Circuit





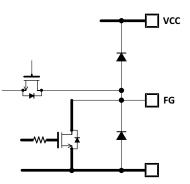


Figure 16. FG Equivalent Circuit

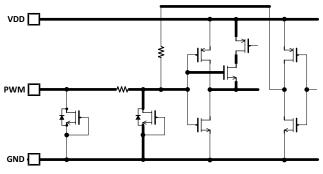


Figure 17. PWM Equivalent Circuit

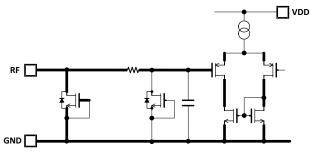
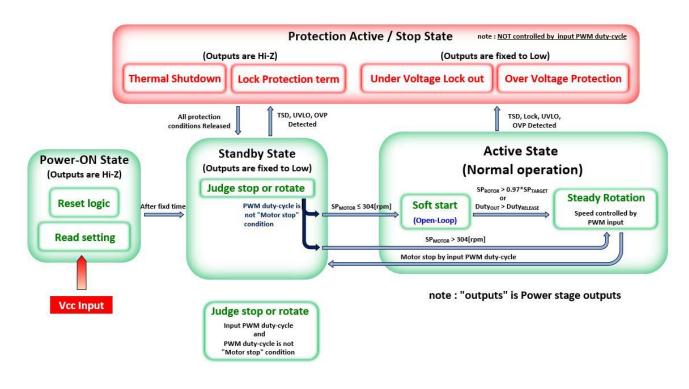


Figure 18. RF Equivalent Circuit

STATE DIAGRAM





FUNCTIONAL DESCRIPTION

Loop Gain

Motor speed loop gain of LV88563 and LV88564 is lower than that of LV88561 and LV88562. If the motor coil current generate large overshoot during motor speed transition, LV88563 and LV88564 can reduce the overshooting current but the motor rotation response speed will decrease. LV88561 and LV88562 are recommended if faster response speed is required.

Current Sense Resistor Pin (RF)

RF is current sense input terminal.

Voltage across the sense resistor represents the motor current and is compared against the internal VTH_{OVC} (0.10 Vtyp.) for setting the over-current limiter (CLM).

VCC and GND Pin (VCC ,GND)

Since Power FET side ground line has to tolerate surge of current, separate it from the GND pin as far away as possible and connect it point-to-point to the ground side of the capacitor (C0) between VCC and GND.

Internal 5.0 V Voltage Regulator Pin (REG, VDD)

REG is internal 5.0 V voltage regulator.

VDD is power supply for internal logic, oscillator, and protection circuits. Please connect REG and VDD.

When PIX, PIZ, RSA, RSB, LAI, LAG and SFS are used, it is recommended that application circuits are made using this output. The maximum load current of REG is 20 mA. Don't exceed this value. Place capacity from 0.1 μ F to 1.0 μ F in the close this pin.

Rotational Signal Pin (FG)

This is an open drain output pin which outputs the rotational signal. In case of LV88561 and LV88563, FG signal will come out from this pin and its frequency will represent electrical speed of a motor.

In case of LV88562 and LV88564, RD signal will come out from this pin. See page 21 "Lock detection and Lock protection" for more information about the RD signal.

Recommended pull up resistor value is 1 k Ω to 100 k Ω . Leave the pin open when not in use.

Output Pins for External FET Control (O1H , O1L , O2H, O2L)

These pins are output for external MOSFET. O1H and O2H connect to upper side P-ch FET's gate-line. O1L and O2L connect to lower side N-ch FET's gate line.

Hall-Sensor Input Pins (IN1, IN2)

Differential output signals of the hall sensor are to be interfaced at IN1 and IN2. It is recommended that 0.01 μ F capacitor is connected between both pins to filter system noise.

When a Hall IC is used, the output of the Hall IC must be connected to the pin IN1. And, the pin IN2 must be kept in the middle level of the Hall IC power supply voltage.

Command Input (PWM)

This pin reads the duty cycle of the PWM pulse and controls rotational speed. The PWM input signal level is supported from 2.5 V to 5 V. The combination with the rotational speed control by DC voltage, is impossible.

When the pin is not used, it must be connected to ground. The minimum pulse width is 100 ns.

Lead-Angle Setting Pin (LAI, LAG)

LV8856xJA/R provides the dynamic lead angle adjustment. To match the motor characteristics, set two point lead–angel, low speed side (set by LAI pin) and high speed side(set by LAG pin).

At middle range of input duty, the lead-angle iis applied to calculated value for relative relationship.

The DC voltage levels applied to these pins are converted to the lead angle parameter. The voltages are fetched right after the power–on–reset. Because the internal conversion circuit works inside REG power rail, it is recommended that the LAI and LAG voltages are made from V_{REG} .

Rotation Speed Setting Pin (RSA, RSB)

LV8856xJA/R provides the feedback speed control, so this device can set the rotation speed value (RPM) directly.

To make the motor speed setting curve, set two point rotation speed value, high speed side and low speed side.

The DC voltage levels applied to these pins are converted to the rotation speed parameter. The voltages are fetched right after the power-on-reset. Because the internal conversion circuit works inside REG power rail, it is recommended that the RSA and RSB voltages are made from V_{REG} .

Rotation Speed Curve Duty Setting Pin (PIX, PIZ)

To make the motor speed setting curve, set two point input duty parameter, high speed side and low speed side.

The DC voltage levels applied to these pins are converted to the input duty parameter. The voltages are fetched right after the power–on–reset. Because the internal conversion circuit works inside REG power rail, it is recommended that the PIX and PIZ voltages are made from V_{REG} .

Soft-Start and Dead Time Setting Pin (SFS)

LV8856xJA/R provides synchronous rectification drive for high efficiency drive. External FET size is variable caused by the motor application. So this driver IC is able to choose 2 types of dead time.

Soft start function pattern is able to choose from 16 types.

The DC voltage levels applied to these pins are converted to the soft-start setting and dead time parameter. The voltage is fetched right after the power-on-reset. Because the internal conversion circuit works inside REG power rail, it is recommended that the SFS voltage is made from V_{REG} .

DETAILED DESCRIPTION

As for all numerical value used in this description, the design value or the typical value is used.

Rotation Speed Curve Setting Description

The LV8856xJA/R can set 2 points speed parameter arbitrarily.

Low speed point (LSP)

High speed point (HSP)

At middle range of input duty, the rotation speed is applied to calculated value for relative relationship.

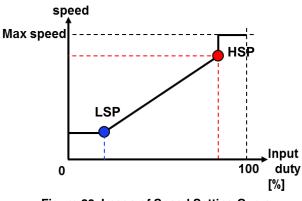


Figure 20. Image of Speed Setting Curve

When the input duty is lower than LSP setting duty, the LV8856xJA/R can select "motor stop" or "keep LSP rotation speed".

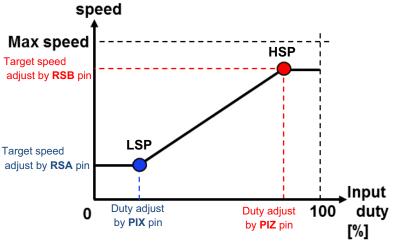
When the input duty is higher than HSP setting duty, the LV8856xJA/R can select "free run" or "keep HSP rotation speed".

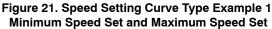
Rotation speed of LSP and HSP is set by RSA and RSB pin. The case of RSA > RSB, "motor stop" mode applied. The case of RSA < RSB, "keep LSP rotation speed" mode applied.

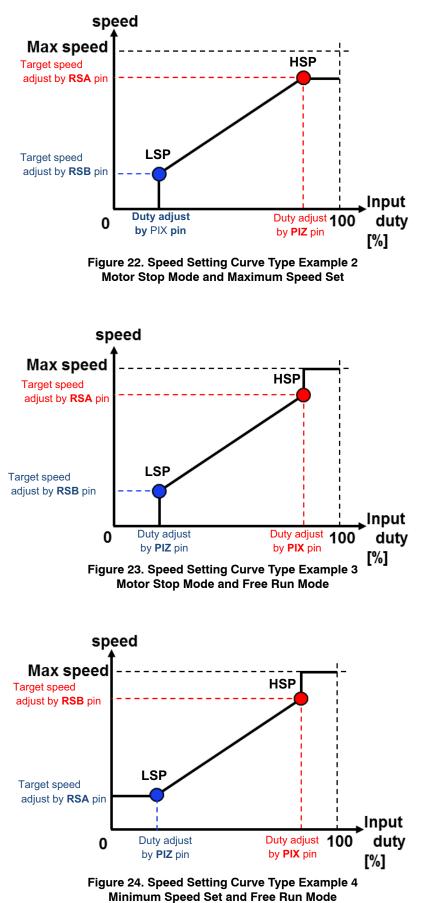
Input duty of LSP and HSP is set by PIX and PIZ pin. The case of PIX > PIZ, "free run" mode applied. The case of PIX < PIZ, "keep HSP rotation speed" mode applied.

So LV8856xJA/R can't set decease speed curve at input duty increase.

Figures 21 – 24 show setting curve example.







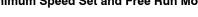
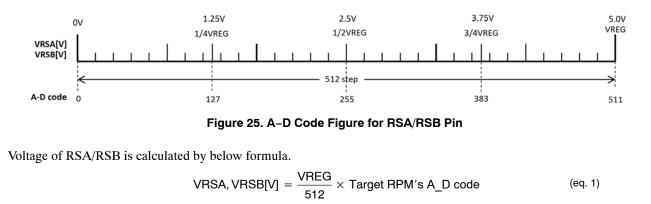


Table 8. ROTATION SPEED SETTING TABLE FOR RSA/RSB PIN

A-D code	RPM	A-D code	RPM	A-D code	RPM	A-D code	RPM	A-D code	RPM	A-D code	RPM	A-D code	RPM	A-D code	RPM
A-D code		A-D code 64	980	128	2180	A-D code 192	4800	256	10800	320	17200	384	23600	448	30000
1	0	65	990	120	2200	192	4850	257	10900	320	17200	385	23700	440	30100
2	0	66	1000	130	2220	190	4900	258	11000	322	17400	386	23800	450	30200
3	0	67	1010	131	2240	195	4950	259	11100	323	17500	387	23900	451	30300
4	0	68	1020	132	2260	196	5000	260	11200	324	17600	388	24000	452	30400
5	0	69	1030	133	2280	197	5050	261	11300	325	17700	389	24100	453	30500
6	400	70	1040	134	2300	198	5100	262	11400	326	17800	390	24200	454	30600
7	410	71	1050	135	2320	199	5150	263	11500	327	17900	391	24300	455	30700
8	420	72	1060	136	2340	200	5200	264	11600	328	18000	392	24400	456	30800
9	430	73	1080	137	2360	201	5300	265	11700	329	18100	393	24500	457	30900
10	440	74	1100	138	2380	202	5400	266	11800	330	18200	394	24600	458	31000
11	450	75	1120	139	2400	203	5500	267	11900	331	18300	395	24700	459	31100
12	460	76	1140	140	2420	204	5600	268	12000	332	18400	396	24800	460	31200
13 14	470 480	77 78	1160 1180	141 142	2440 2460	205 206	5700 5800	269 270	12100 12200	333 334	18500 18600	397 398	24900 25000	461 462	31300 31400
14	480	78	1200	142	2460	206	5900	270	12200	334	18600	398	25000	462	31400
15	500	80	1200	143	2480	207	6000	271	12300	336	18800	400	25200	403	31600
17	510	81	1240	145	2520	209	6100	273	12500	337	18900	400	25300	465	31700
18	520	82	1240	146	2540	210	6200	274	12600	338	19000	402	25400	466	31800
19	530	83	1280	147	2560	211	6300	275	12700	339	19100	403	25500	467	31900
20	540	84	1300	148	2600	212	6400	276	12800	340	19200	404	25600	468	32000
21	550	85	1320	149	2650	213	6500	277	12900	341	19300	405	25700	469	32100
22	560	86	1340	150	2700	214	6600	278	13000	342	19400	406	25800	470	32200
23	570	87	1360	151	2750	215	6700	279	13100	343	19500	407	25900	471	32300
24	580	88	1380	152	2800	216	6800	280	13200	344	19600	408	26000	472	32400
25	590	89	1400	153	2850	217	6900	281	13300	345	19700	409	26100	473	32500
26	600	90	1420	154	2900	218	7000	282	13400	346	19800	410	26200	474	32600
27	610	91	1440	155	2950	219	7100	283	13500	347	19900	411	26300	475	32700
28 29	620 630	92 93	1460 1480	156 157	3000 3050	220 221	7200 7300	284 285	13600 13700	348 349	20000 20100	412 413	26400 26500	476 477	32800 32900
30	640	93 94	1480	157	3030	221	7300	285	13700	349	20100	413	26600	477	32900
31	650	94 95	1500	158	3150	222	7500	280	13900	351	20200	414	26700	479	33100
32	660	96	1540	160	3200	224	7600	288	14000	352	20400	416	26800	480	33200
33	670	97	1560	161	3250	225	7700	289	14100	353	20500	417	26900	481	33300
34	680	98	1580	162	3300	226	7800	290	14200	354	20600	418	27000	482	33400
35	690	99	1600	163	3350	227	7900	291	14300	355	20700	419	27100	483	33500
36	700	100	1620	164	3400	228	8000	292	14400	356	20800	420	27200	484	33600
37	710	101	1640	165	3450	229	8100	293	14500	357	20900	421	27300	485	33700
38	720	102	1660	166	3500	230	8200	294	14600	358	21000	422	27400	486	33800
39	730	103	1680	167	3550	231	8300	295	14700	359	21100	423	27500	487	33900
40	740	104	1700	168	3600	232	8400	296	14800	360	21200	424	27600	488	34000
41	750	105	1720	169	3650	233	8500	297	14900	361	21300	425	27700	489	34100
42 43	760	106 107	1740 1760	170	3700	234 235	8600	298 299	15000 15100	362 363	21400 21500	426 427	27800	490	34200 34300
43	770 780	107	1760	171 172	3750 3800	235	8700 8800	299 300	15100	363	21500	427 428	27900	491 492	34300
44	780	108	1800	172	3850	230	8900	300	15200	365	21000	428	28000	492	34400
45	800	1109	1800	173	3900	238	9000	301	15400	366	21700	429	28200	493	34600
40	810	111	1840	175	3950	239	9100	303	15500	367	21900	431	28300	495	34700
48	820	112	1860	176	4000	240	9200	304	15600	368	22000	432	28400	496	34800
49	830	113	1880	177	4050	241	9300	305	15700	369	22100	433	28500	497	34900
50	840	114	1900	178	4100	242	9400	306	15800	370	22200	434	28600	498	35000
51	850	115	1920	179	4150	243	9500	307	15900	371	22300	435	28700	499	35100
52	860	116	1940	180	4200	244	9600	308	16000	372	22400	436	28800	500	35200
53	870	117	1960	181	4250	245	9700	309	16100	373	22500	437	28900	501	35300
54	880	118	1980	182	4300	246	9800	310	16200	374	22600	438	29000	502	35400
55	890	119	2000	183	4350	247	9900	311	16300	375	22700	439	29100	503	35500
56	900	120	2020	184	4400	248	10000	312	16400	376	22800	440	29200	504	35600
57	910 920	121 122	2040 2060	185	4450	249	10100	313	16500	377 378	22900	441 442	29300	505 506	35700
58 59	920 930	122	2060	186 187	4500 4550	250 251	10200	314 315	16600 16700	378	23000 23100	442	29400 29500	506	35800 35900
59 60	930 940	123	2080	187	4550	251	10300	315	16700	379	23100	443	29500	507	36000
61	940	124	2100	189	4650	252	10400	310	16900	380	23200	444	29000	509	36000
62	960	125	2140	190	4700	254	10600	318	17000	382	23400	446	29800	510	36000
63	970	127	2160	191	4750	255	10700	319	17100	383	23500	447	29900	511	36000



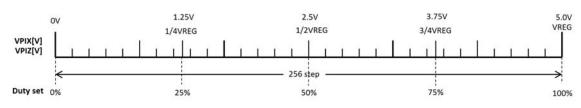


Figure 26. Input Duty Parameter Setting for PIX/PIZ Pin

Voltage of PIX/PIZ is calculated by below formula.

$$VPIX, VPIZ[V] = VREG \times \frac{\text{Target Duty[\%]}}{100}$$
(eq. 2)

Lead-angle Setting Description

LV8856xJA/R provides the dynamic lead angle adjustment. To match the motor characteristics, set two points lead-angel amounts. Settable range is -22.225° to $+22.225^{\circ}$ (0.175° step). LSP's value is set by LAI pin and

HSP's value is set by LAG pin. At middle range of input duty, the lead-angle is applied to calculated value for relative relationship.

LV8856xJA/R can set delay angle setting. Minus value means delay angle.

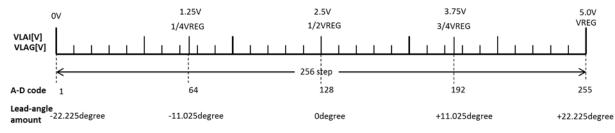


Figure 27. Lead-angle Parameter Setting for LAI/LAG Pin

Voltage of LAI/LAI is calculated by below formula.

$$VLAI, VLAG[V] = \frac{VREG}{2} + VREG \times \frac{Target Lead Angle Value [°]}{44.45}$$
(eq. 3)

Lead angle amounts of LSP and HSP doesn't care each relationship of large/small.

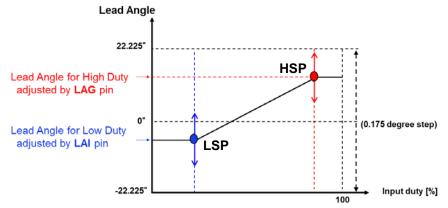


Figure 28. Image of Lead Angle Setting Curve

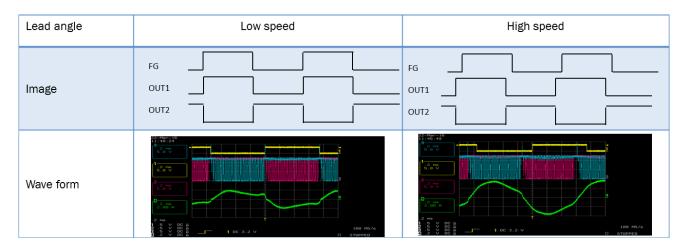


Figure 29. Lead Angle Image Waveform

Soft-Start Setting Description

LV8856xJA/R has soft start function.

To avoid the motor rush current, the output PWM duty rise–up from zero slowly at the starting of motor rotation.

The soft start action release conditions are below;

Rotation speed reach to target speed decided by PWM input.

Output duty reach to "Release duty".

When reached to the release condition, change to closed–loop speed control mode.

If the motor can't rotation during 0.7s (typ), lock protection function will activate.

The recommendation of soft-start time is 1.72 s. Hence, it can be set by A–D code "0" and "31" for easy implementation by pin pull-down or pull-up.

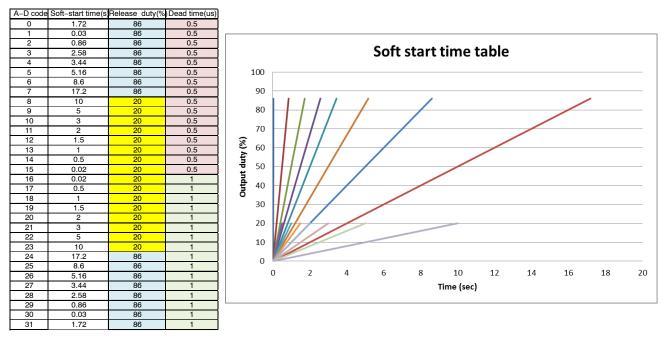
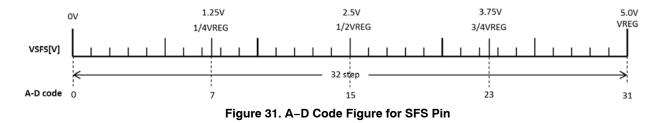


Figure 30. Soft-start and Dead Time Setting Table for SFS Pin



Voltage of SFS is calculated by below formula.

 $VSFS[V] = \frac{VREG}{32} \times Target Setting's A_D Code (eq. 4)$

Output Waveform

LV8856xJA/R output PWM frequency is fixed by the inner oscillator parameter, 48 kHz (typ) which doesn't depend on input PWM frequency.

Driving method of LV8856xJA/R uses PWM soft switching drive.

Soft switching width is changed by input PWM duty.

When the input duty is HSP setting duty, soft switching width is narrow (S/L = 20.5%)

On the other hand when the input duty is LSP setting duty, soft switching width becomes wide (S/L = 46.9%)

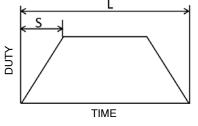


Figure 32. Image of Soft Switching Width

In this part, the rise/fall time of soft switching waveform is equal. Therefore, the "S" in the figure can be also applied to fall time as well. At the middle range input duty, the soft switching width is applied to calculated value for relative relationship.

Protections

LV8856xJA/R has some protection function.

- Thermal shutdown protection (TSD)
- Under voltage lock out (UVLO)
- Current limiter (CLM)
- Lock protection

When TSD or Lock protection is working, external FETs are all turned off.

On the other hand, when UVLO or CLM is working, output is turned off and goes into re-circulation state.

Thermal Shutdown Protection (TSD)

When this IC's junction temperature rises to 180°C (typ), O1H/O2H output turns to high, and O1L/O2L output turn to low. External FETs are all turns off and coil current is shut off.

Next, when IC's junction temperature falls to $140^{\circ}C$ (typ), thermal shutdown function is released and motor starts to rotate.

Under Voltage Lock Out (UVLO)

UVLO work voltage: VCC 3.4 V (typ)

UVLO release voltage: VCC 3.6 V (typ)

Current Limiter (CLM)

When the coil current increases and the voltage of the RF pin rises to 0.1 V (typ), the CLM operates and shut the coil current.

CLM current is adjustable by resistor value between RF-GND.

The sense resistor value is calculated as follows.

Sense Resistor[
$$\Omega$$
] = $\frac{VTH_{CLM}[V]}{I_{CLM}[A]}$ (eq. 5)

For example, to set the CLM current threshold at 2A, the sense resistor value is

Sense Resistor =
$$\frac{0.10(typ)}{2.0}$$

Res = 0.05 [Ω] (eq. 6)

Lock Detection and Lock Protection

When the motor lock is happened, heat is generated because IC continues to supply electricity to the motor. And IC detects this radiated heat and turns off the electricity to the motor.

If IC does not receive the FG edge for 0.3sec (under 50rpm), the IC judges "motor lock" has occurred and the lock protection function will activate. In this mode, the RD signal goes to "High", though it is "Low" at motor starts.

When the motor restarts and IC detects 4 phase changes, the RD signal goes to "Low".

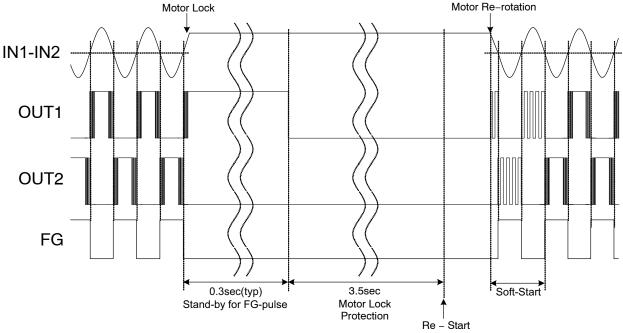


Figure 33. Image of Lock Detection and Lock Protection

It takes 3.5s for Lock protection time(1^{st} to 4^{th} protection time). This equals to the total of lock detection time and lock protection time. The lock detection time – the ratio is approx. 1:5 (from 1^{st} to 4^{th} protection time).

After 5th protection time, the lock protection time becomes 14s and protection–start time ratio is approx. 1:20 (after 5th protection time)

When the motor rotation is stopped by PWM input signal, the lock detection is reset and the motor starts to rotate smoothly once the IC receives the rotation start instruction.

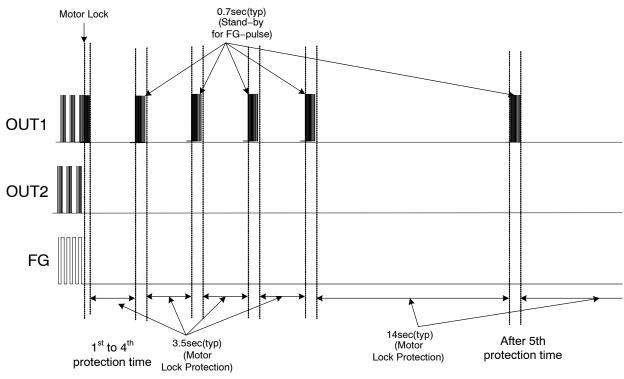


Figure 34. Image of Lock Protection Time

PCB GUIDELINES

VCC and Ground Routing

Make sure to short-circuit power line externally by a low impedance route on one side of PCB. As high current flows into external FET to GND, connect it to GND through a low impedance route.

The capacitance connected between the VCC pin and the opposite ground is to stabilize the battery. Make sure to connect an electrolytic capacitor with capacitance value of about $1 \,\mu\text{F}$ (0.1 μF or greater) to eliminate low frequency noise. Also, to eliminate high frequency noise, connect a capacitor of superior frequency characteristics, with capacitance value of about 0.1 μ F and make sure that the capacitor is connected as close to the pin as possible. Allow enough room in the design so the impact of PWM drive and flyback do not affect other components. Especially, when the coil inductance is large and/or the coil resistance is small, current ripple will rise so it is necessary to use a high-capacity capacitor with superior frequency characteristics. Please note that if the battery voltage rises due to the impact of the coil flyback as a result of the use of diode for preventing the break down caused by reverse connection, it is necessary to either increase the capacitance value or place Zener diode between the battery and the ground so that the voltage does not exceed its absolute maximum voltage.

When the electrolytic capacitor cannot be used, add the resistor with the value of about 1 Ω and a ceramic capacitor with the capacitor value of about 10 μ F in series for the alternative use. When the battery line is extended,

(20-30 cm to 2-3 m), the battery voltage may overshoot when the power is supplied due to the impact of the routing of the inductance. Make sure that the voltage does not exceed the absolute maximum standard voltage when the power supply turns on.

These capacitance values are just for reference, so the confirmation with the actual application is essential to determine the values appropriately.

RF Routing

Power current (output current) flows through the RF line. Make sure to short–circuit the line from RF through GND as well as GND. The RF resistance must choose enough power rating.

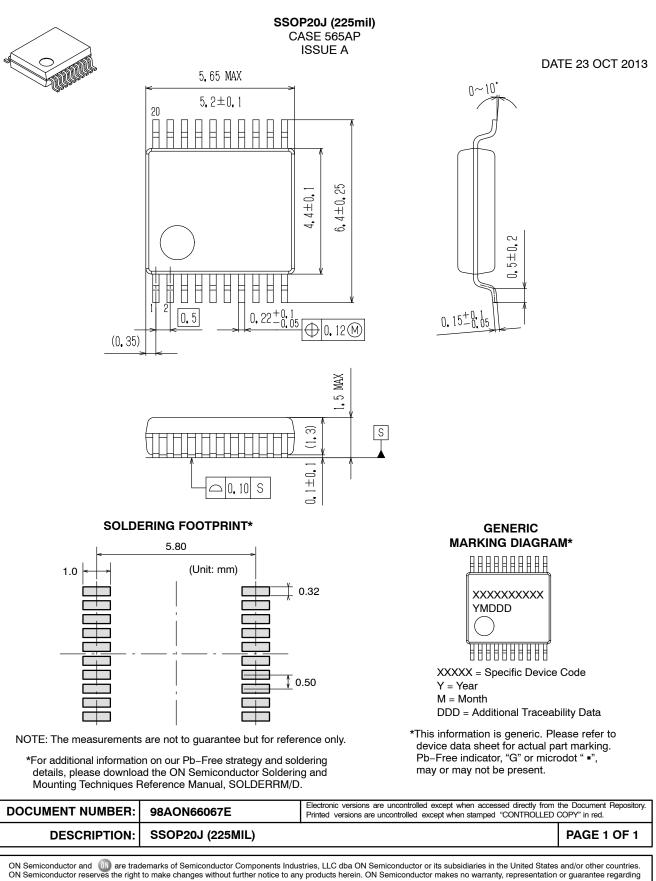
External FET Output Pins

Since the pins have to tolerate surge of current, make sure that the wires are thick and short enough when designing the PCB board.

Thermal Test Conditions

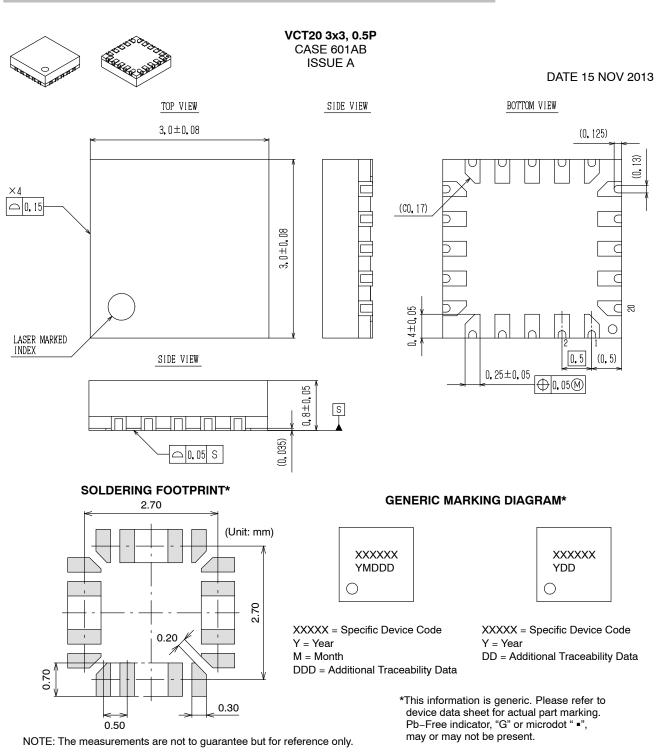
LV8856xJA (x = 1,2,3 or 4) Size: 114.3 mm x 76.1 mm x 1.6 mm Material: Glass epoxy single layer board LV8856xR (x = 1,2,3 or 4) Size: 50.0 mm x 40.0 mm x 0.8 mm Material: Glass epoxy 4–layer board





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